TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

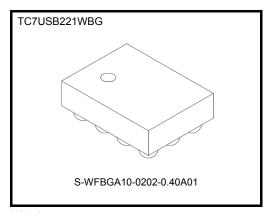
# TC7USB221WBG

#### **Dual SPDT USB Switch**

TC7USB221 is high-speed CMOS dual 1-2 multiplexer /demultiplexer. The low ON-resistance and the low capacitance of the switch allow connections to USB application.

This device consists of dual individual two-inputs multiplexer/demultiplexer with common select input (S) and output enable ( $\overline{OE}$ ). The D+/D- inputs is connected to the D1+/D1- or D2+/D2- outputs determined by the combination both the select input (S) and output enable ( $\overline{OE}$ ). When the output enable ( $\overline{OE}$ ) input is held "H" level, the switches are open with regardless the state of select inputs and a high-impedance state exists between the switches.

All inputs are equipped with protection circuits against static discharge.



Weight S-WFBGA10-0202-0.40A01: 0.0025 g (typ.)

#### **Features**

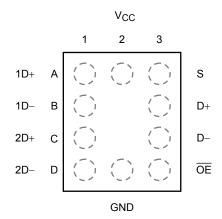
- Operating voltage: VCC = 2.3 to 3.6 V
- ON-capacitance: C<sub>I/O</sub> = 7 pF Switch ON(typ.)@V<sub>CC</sub>=3.3 V
- ON-resistance:  $R_{ON} = 6.5 \Omega$  (typ.)@V<sub>CC</sub>=3 V,  $V_{I/O}$ =0 V
- Ron Flatness:  $R_{ON(flat)} = 1.6 \Omega \text{ (typ.)@V}_{CC} = 3 \text{ V}$
- Delta Ron:  $\Delta R_{ON} = 0.5 \Omega \text{ (typ.)@V}_{CC} = 3 \text{ V}$
- ESD performance: Machine model  $\geq \pm 200 \text{ V}$

Human body model  $\geq \pm 2000 \text{ V}$ 

- Power-down protection for inputs (OE and S, I/O)
- Package: WCSP10

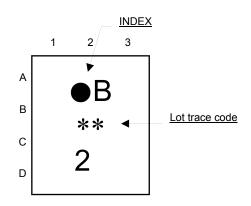
#### Pin Assignment (top view)

WBG (S-WFBGA10-0202-0.40A01)



#### Marking

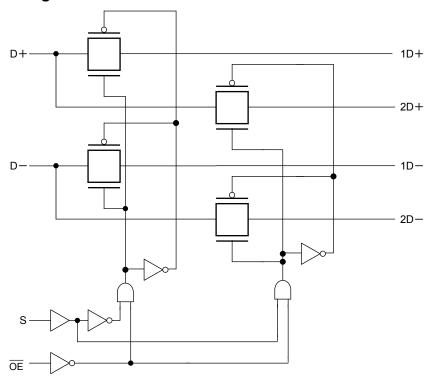
WBG (S-WFBGA10-0202-0.40A01)



## **Truth Table**

Inp	outs	Function					
ŌĒ	S	Function					
L	L	D+ port = 1D+ port, D- Port = 1D- Port					
L	Н	D+ port = 2D+ port, D- Port = 2D- Port					
Н	X	Disconnect					

## System Diagram



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#### **Absolute Maximum Ratings (Note)**

Charact	eristic	Symbol	Rating	Unit	
Power supply range		V <sub>CC</sub>	-0.5 to 4.6	V	
Control pin input voltage	( OE, S)	V <sub>IN</sub>	-0.5 to 4.6	V	
Switch terminal I/O voltage	V <sub>CC</sub> =0 V or Switch=Off	Vs	-0.5 to 4.6	V	
	Switch=On	vs	-0.5 to V <sub>CC</sub> +0.5		
Clump diode current	Control input	luz	-50	mA	
	Switch	lik	±50		
Switch I/O current		I <sub>S</sub> 50		mA	
Power dissipation		P <sub>D</sub>	150		
DC V <sub>CC</sub> /GND current		I <sub>CC</sub> /I <sub>GND</sub>	±100	mA	
Storage temperature		T <sub>stg</sub>	-65 to 150	°C	

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction. Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Operating Ranges (Note)**

Chara	cteristic	Symbol	Rating	Unit	
Power supply voltage		V <sub>CC</sub>	2.3 to 3.6	V	
Control pin input voltage	( $\overline{OE}$ , S)	V <sub>IN</sub>	0 to 3.6	V	
Switch I/O voltage	V <sub>CC</sub> =0 V or Switch=Off	V	0 to 3.6	V	
	Switch=On	V <sub>S</sub>	0 to V <sub>CC</sub>		
Operating temperature		T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time		dt/dv	0 to 10	ns/V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

### **Electrical Characteristics**

### DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Character	Characteristics Symbol Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Unit	
Input voltage	"H" level	V <sub>IH</sub>	_	2.3 to 3.6	0.46 × V <sub>CC</sub>	_	_	V
( $\overline{OE}$ , S)	"L" level	V <sub>IL</sub>	_	2.3 to 3.6	_	_	0.25 × V <sub>CC</sub>	V
Input leakage current ( OE , S)		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V	2.3 to 3.6	_	_	±1.0	μА
Power-off leakage current		l <sub>OFF</sub>	V <sub>IN</sub> = 0 to 3.6 V		_	_	±5.0	μΑ
Off-state leakage current (switch off)		I <sub>SZ</sub>	D+, D- = 0 to $V_{CC}$ , $\overline{OE} = V_{CC}$	2.3 to 3.6	_	_	±5.0	μА
ON resistance (Note2)			$V_{IS} = 0 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note1)	3.0	_	6.5	10	
		R <sub>ON</sub>	$V_{IS} = 0.4 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note1)	3.0	_	7	11	Ω
			$V_{IS} = 3.0 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note1)	3.0	_	13	19	
Delta R <sub>ON</sub>		ΔR <sub>ON</sub>	V <sub>IS</sub> = 0.4 V, 1.0V, I <sub>IS</sub> = 30 mA	3.0	_	0.5		Ω
On-Resistance Flatness		R <sub>ON(flat)</sub>	$V_{IN}$ = 0V to 1.0V, $I_{IS}$ = 30 mA 3.0			1.6		Ω
Quiescent supply current		Icc	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ 3.6		_	_	2.0	μΑ
Increase in I <sub>CC</sub> per input		ΔI <sub>CC</sub>	V <sub>IN</sub> = 1.8V	3.6	_	_	10.0	μА

Note1: All typical values are at Ta = 25°C.

Note2: Measured by the voltage drop between D+/D- and D1+/D1-, D2+/D1- pins at the indicated current through the switch. ON resistance is determined by the lower of the voltages on the two pins.



## AC Characteristics $V_{CC}$ =3.3V± 10% (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Propagation Delay Time (Note)	tpd	C <sub>L</sub> =5 pF	3.3 ± 0.3	_	0.25	_	ns
Turn ON Time (S, OE to Output)	t <sub>ON</sub>	R <sub>L</sub> =50 $\Omega$ , C <sub>L</sub> =5 pF	3.3 ± 0.3	_	7.5	17	ns
Turn OFF Time (S, OE to Output)	tOFF	R <sub>L</sub> =50 Ω, C <sub>L</sub> =5 pF	3.3 ± 0.3	_	3.3	10	ns
Break Before Make	ТВВМ	R <sub>L</sub> =50 Ω, C <sub>L</sub> =5 pF	3.3 ± 0.3	2	_	7.0	ns
Output skew between center port to any other port (Note)	t <sub>SK(O)</sub>	C <sub>L</sub> =5 pF	3.3 ± 0.3	_	0.1	_	ns
Skew of Opposite Transitions of the same output (tp <sub>HL</sub> - tp <sub>LH</sub> ) (Note)	t <sub>SK(P)</sub>	C <sub>L</sub> =5 pF	3.3 ± 0.3		0.1		ns
Off Isolation (Non-Adjacent)	OIRR	R <sub>T</sub> =50 Ω, f=240 MHz	3.3 ± 0.3	_	-36	_	dB
Crosstalk(Non-Adjacent)	XTalk	R <sub>T</sub> =50 Ω, f=240 MHz	3.3 ± 0.3		-36	_	dB
-3dB Bandwidth	BW	R <sub>T</sub> =50 $\Omega$ ,C <sub>L</sub> =0 pF	3.3 ± 0.3	_	820	_	MHz

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Note: This parameter is guaranteed by design.

## **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Control pin input capaci tance ( $\overline{OE}$ , $S$ )	C <sub>IN</sub>	$V_{IN} = 0 V$ (Note)	3.3	4	pF
Switch terminal Off capacitance ( D+, D-)	C <sub>I/O</sub>	$V_{IS} = 0 \text{ V}, \overline{OE} = V_{CC}$ (Note)	3.3	4	pF
Switch terminal Off capacitance (1D+,1D-,2D+,2D-)	C <sub>I/O</sub>	$V_{IS} = 0 \text{ V}, \overline{OE} = V_{CC}$ (Note)	3.3	3	pF
Switch terminal On capacitance	C <sub>I/O</sub>	$V_{IS} = 0 \text{ V}, \overline{OE} = GND$ (Note)	3.3	7	pF

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Note: This parameter is guaranteed by design.

### **AC Test Circuit Load/Waveform**

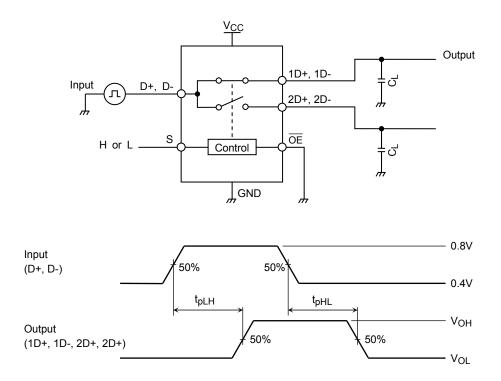


Figure 1 : Propagation Delay Time  $(t_{pLH},\,t_{pHL})$ 

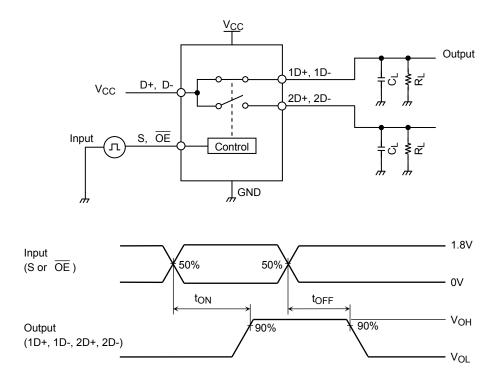


Figure 2: Turn ON/Turn OFF (ton, toff)

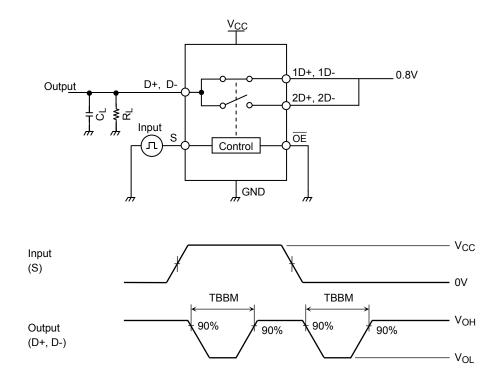
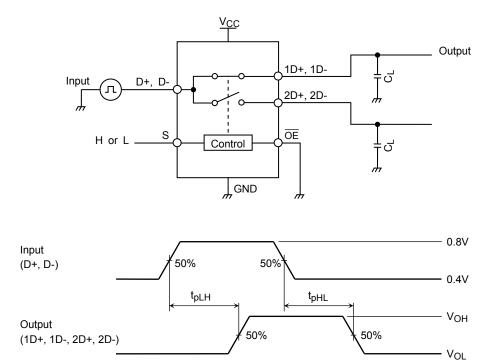
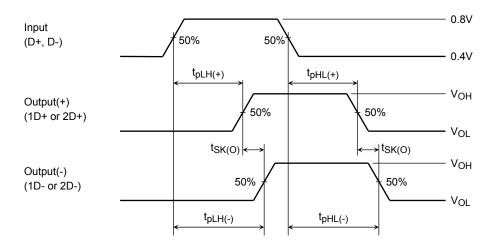


Figure 3 : Break Before Make (TBBM)

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PULSE SKEW  $t_{SK(P)} = |t_{pLH} - t_{pHL}|$ 

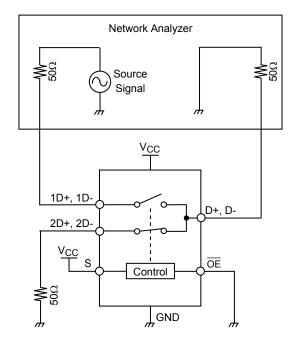


OUTPUT SKEW  $t_{SK(O)} = |t_{pLH(+)} - t_{pLH(-)}|$  or  $|t_{pHL(+)} - t_{pHL(-)}|$ 

Figure 4 : Skew of Opposite Transitions of the same output, Output skew

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Network Analyzer

Source Signal

VCC

Signal

D+, D
VCC

Source Signal

Network Analyzer

Figure 5 : Channel OFF Isolation

Figure 6 : Crosstalk

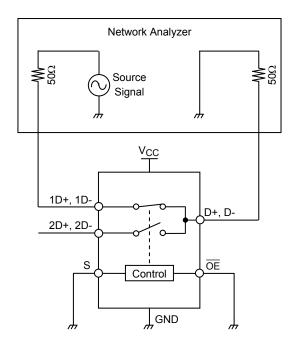


Figure 7: -3dB Bandwidth

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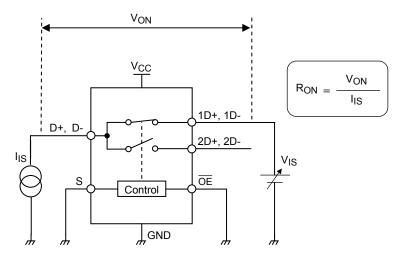


Figure 8 : ON Resistance

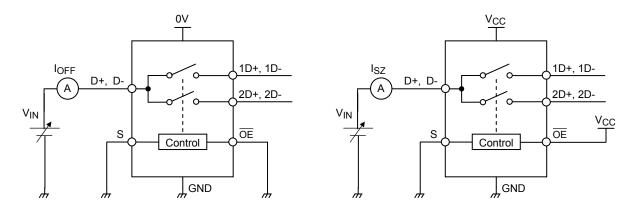


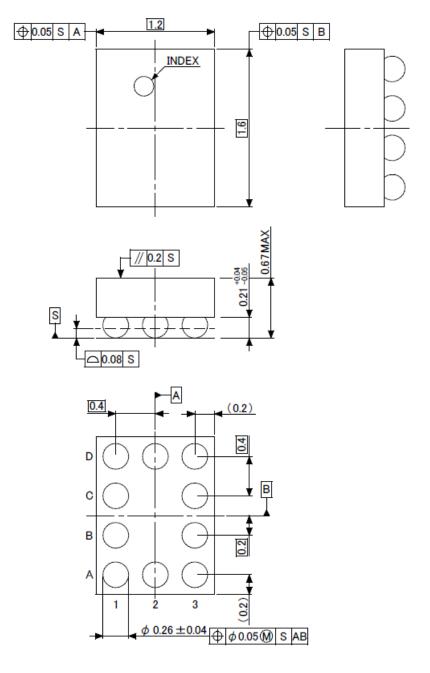
Figure 9 : Power off Leakage Current

Figure 10 : Off-State Leakage current

## **Package Dimension**

S-WFBGA10-0202-0.40A01

Unit: mm



The resin used in this product includes no flame retardants.

Weight: 0.0025g (Typ.)

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